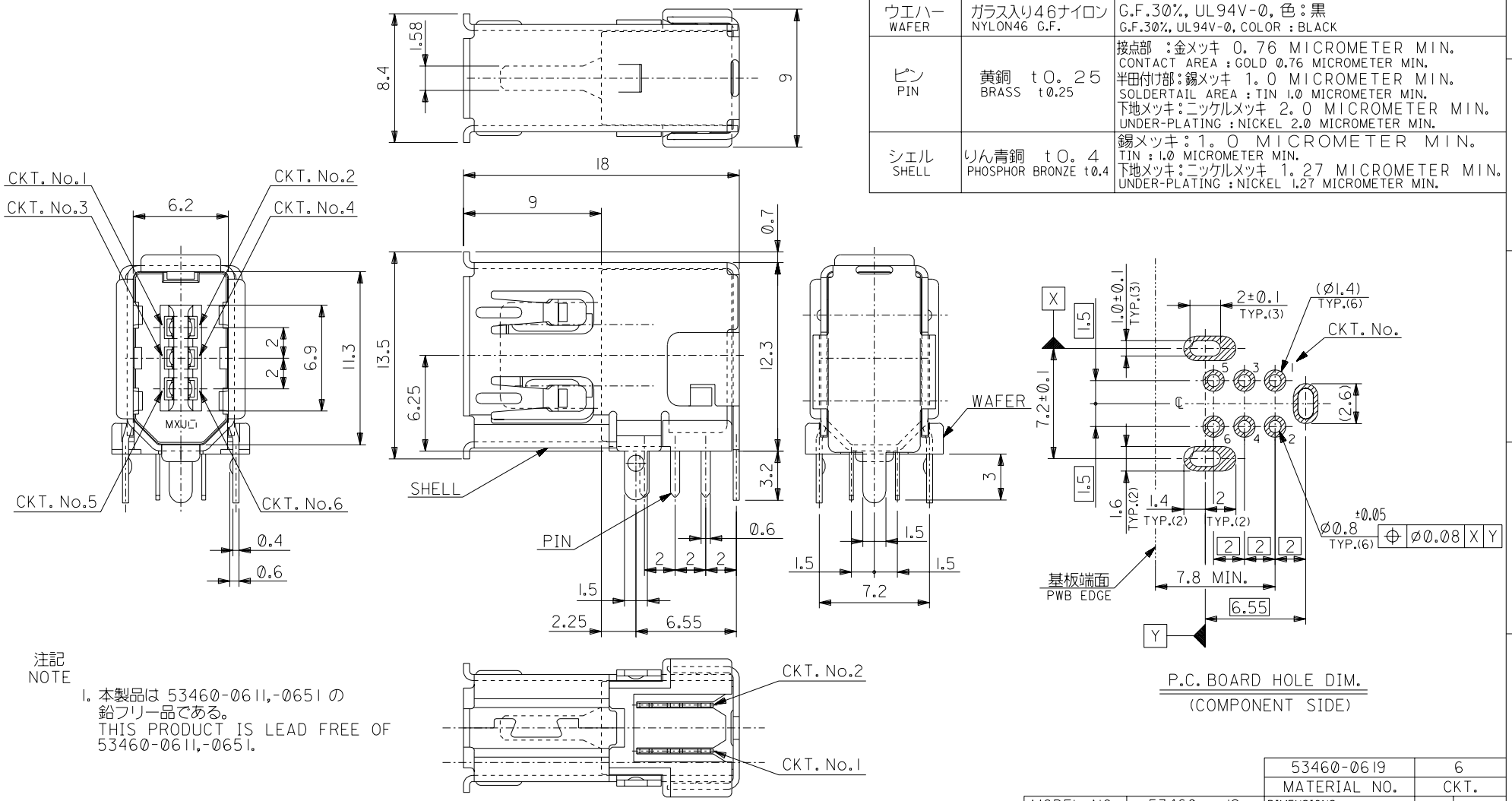
DWG. NO. SD-53460-020

部品名 PARTS NAME	材質 MATERIAL	注記 NOTES
ウエハー WAFER	ガラス入り46ナイロン NYLON46 G.F.	G.F.30%, UL94V-0, 色：黒 G.F.30%, UL94V-0, COLOR : BLACK
ピン PIN	黄銅 t0.25 BRASS t0.25	接点部 ：金メッキ 0.76 MICROMETER MIN. CONTACT AREA : GOLD 0.76 MICROMETER MIN. 半田付け部：錫メッキ 1.0 MICROMETER MIN. SOLDERTAIL AREA : TIN 1.0 MICROMETER MIN. 下地メッキ：ニッケルメッキ 2.0 MICROMETER MIN. UNDER-PLATING : NICKEL 2.0 MICROMETER MIN.
シェル SHELL	りん青銅 t0.4 PHOSPHOR BRONZE t0.4	錫メッキ：1.0 MICROMETER MIN. TIN : 1.0 MICROMETER MIN. 下地メッキ：ニッケルメッキ 1.27 MICROMETER MIN. UNDER-PLATING : NICKEL 1.27 MICROMETER MIN.



P.C. BOARD HOLE DIM.
(COMPONENT SIDE)

注記
NOTE

1. 本製品は 53460-0611,-0651 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 53460-0611,-0651.

53460-0619	6
MATERIAL NO.	CKT.
MODEL NO. 53460-**19	SHT / REV
DIMENSIONS: ☐mm/INCH ☐INCH/mm ☒mm ONLY	REVISE ON CAD ONLY
SCALE 4:1	DESIGN UNITS ☒mm ☐INCH
THIRD ANGLE PROJECTION	
TITLE: 2.0 I/O CONN. SOCKET RIGHT-ANGLE UPRIGHT -LEAD FREE-	
DRAWN BY & DATE Y.WADA '04/05/14	
CHECKED BY & DATE M.SASAO '04/05/14	
APPROVED BY & DATE M.SASAO '04/05/14	
MOLEX INCORPORATED	
CAD FILENAME SD-53460-020.S01	MATERIAL NO. SEE CHART
DRAWING NO. SD-53460-020	SHEET NO. 1 OF 1
SIZE B	

EC NO.	DESCRIPTION	REV
J2004-4243	RELEASED	0
DRWN: Y.WADA '04/05/14		
CH'K: M.SASAO '04/05/14		
APPR: M.SASAO '04/05/14		

DO NOT SCALE DRAWING

MATERIAL 材料: 表参照 SEE TABLE
FINISH 仕上げ: 表参照 SEE TABLE
WIRE RANGE 適用電線範囲
INS. RANGE 被覆外径

GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差

10 UNDER 未満	±0.2
10 OVER 以上 30 UNDER 未満	±0.25
30 OVER 以上	±0.3
ANGLE 角度	±3°

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.